

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:

Hyunjung Lee

Attorney Docket No.: 2156-612A

Serial No.: 10/798,522

Art Unit: 1753

Filing Date: March 11, 2004

Examiner: E. Wong

Title: Process for Preparing a Non-Conductive Substrate for Electroplating

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER NOTICE OF ALLOWANCE UNDER 37 CFR 1.312

Prior to payment of the issue fee, please amend the above-entitled application as follows:

(W1403387)